



Form Type	Distribute	Version	2.0	Ref	IPC 1752A	Sectionals	Material Info	Subsectionals	D, A
Supplier Information									
Company Name	TE Connectivity	Request Document ID		Contact Name	Benfer, David W	Contact Title	Prod Compliance Engineer		
Company Unique ID	TE Connectivity	Response Date	2018-03-04	Contact Email	dave.benfer@te.com				
Contact Phone Number	717-986-3725								
Legal Statement									
Supplier Acceptance	true								
Legal Statement									
The information provided in this document is based upon reasonable inquiry of our suppliers. This information is subject to change. This information does not in any way modify existing purchase specifications or existing contractual or other agreements terms between TE Connectivity (or its affiliated companies) and its customers.									
Product									
Manufacturer Item number	2-1734035-4	Amount	1160.0	Version	-	Identity			
Manufacturer Item Name	Mini USB,R/A,SMT,matte tin,w/ mylar	Weight Uom	mg	Mfr Site		Authority			
Date		UOM	Each						
EUroHS-0508	Product(s) meets EU RoHS requirement without any exemptions								
ChinaRoHS-0508	Product(s) is eligible for marking with the e code under China's Measures for Administration of the control of pollution by Electronic Information Products								
EUREACH-0117	REACH Candidate Substances of Very High Concern ARE NOT Contained in the Product Above the Limits per the Definition within REACH								
Complex Article Description	REACH Candidate Substances of Very High Concern according to Once an Article Always an Article are Not Yet Reviewed								
Product Disclosure									
Sub-Item/Material/Substance	Level	Name	Substance Category	Substance CAS	Substance Concentration	Quantity	Mass per Unit	UOM	Exemption
Material	1	Contact Plating Pd-Ni				1.0	0.3	mg	
Substance	2	Palladium	Supplier	7440-05-3	80.0	1.0	0.24	mg	
Substance	2	Nickel	Nickel	7440-02-0	20.0	1.0	0.06	mg	
Material	1	Shell_SUS304				1.0	422.7	mg	
Substance	2	Chromium	Supplier	7440-47-3	20.0	1.0	84.54	mg	
Substance	2	Manganese	Supplier	7439-96-5	2.0	1.0	8.454	mg	
Substance	2	Silicon	Supplier	7440-21-3	1.0	1.0	4.227	mg	
Substance	2	Iron	Supplier	7439-89-6	66.345	1.0	280.44032	mg	
Substance	2	Phosphorus	Supplier	7723-14-0	0.045	1.0	0.19022	mg	
Substance	2	Carbon	Supplier	7440-44-0	0.08	1.0	0.33816	mg	
Substance	2	Sulfur	Supplier	7704-34-9	0.03	1.0	0.12681	mg	
Substance	2	Nickel	Nickel	7440-02-0	10.5	1.0	44.3835	mg	
Material	1	Contact Plating Sn				1.0	0.3	mg	
Substance	2	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-0217	0.1	1.0	3.0E-4	mg	
Substance	2	Tin	Supplier	7440-31-5	99.9	1.0	0.2997	mg	
Material	1	Shell Plating Ni				1.0	0.3	mg	
Substance	2	Nickel	Nickel	7440-02-0	99.8	1.0	0.2994	mg	
Substance	2	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-0217	0.2	1.0	6.0E-4	mg	
Material	1	Mylar				1.0	370.0	mg	
Substance	2	1-Propene, homopolymer	Supplier	9003-07-0	100.0	1.0	370.0	mg	
Material	1	Housing				1.0	137.0	mg	
Substance	2	Benzene, ethenyl-, homopolymer, brominated	Supplier	88497-56-7	22.0	1.0	30.14	mg	
Substance	2	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-0217	3.0	1.0	4.11	mg	

Substance	2	1,4-Benzenedicarboxylic acid, polymer with 2-methyl-1,8-octanediamine and 1,9-nonanediamine	Supplier	169284-22-4	40.0	1.0	54.8	mg	
Substance	2	Carbon black	Supplier	1333-86-4	2.0	1.0	2.74	mg	
Substance	2	Glass, oxide, chemicals	Supplier	65997-17-3	33.0	1.0	45.21	mg	
Material	1	Contact				1.0	228.8	mg	
Substance	2	Phosphorus	Supplier	7723-14-0	0.19	1.0	0.43472	mg	
Substance	2	Tin	Supplier	7440-31-5	6.25	1.0	14.3	mg	
Substance	2	Copper	Supplier	7440-50-8	93.56	1.0	214.06528	mg	
Material	1	Contact Plating Au				1.0	0.3	mg	
Substance	2	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-0217	0.1	1.0	3.0E-4	mg	
Substance	2	Gold	Supplier	7440-57-5	99.9	1.0	0.2997	mg	
Material	1	Contact Plating Ni				1.0	0.3	mg	
Substance	2	Nickel	Nickel	7440-02-0	99.8	1.0	0.2994	mg	
Substance	2	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-0217	0.2	1.0	6.0E-4	mg	